■ MN101C57C, MN101C57D

Туре	MN101C57C (under development)	MN101C57D (under development)					
ROM (x8-bit)	48 K	64 K					
RAM (×8-bit)	2 K	2 K					
Package	QFP100-P-1818B *Lead-free (under development), LQFP100-P-1414 *Lead-free (under pla						
Minimum Instruction Execution Time	0.1 μs (at 4.5 V to 5.5 V, 20 MHz) 0.25 μs (at 2.7 V to 5.5 V, 8 MHz) 62.5 μs (at 2.0 V to 5.5 V, 32 kHz)* * The lower limit for operation guarantee for flash memory built-in type is 2.5 V.						
Interrupts	• RESET • Watchdog • External 0 • External 1 • External 2 • External 3 • External 4 (key interrupt selectable) • External 5 (key interrupt dedicated) • External 6 • External 7 • Remote control • Timer 0 • Timer 1 • Timer 2 • Timer 3 • Timer 6 • Time base • Timer 7 (2 systems) • Timer 8 (2 systems) • Serial 0 (2 systems) • Serial 2 • A/D conversion finish						
Timer Counter	Timer counter 0: 8-bit × 1 (square-wave/8-bit PWM output, event count, generation of remote control carrier, simple pulse width measurement) (square-wave/PWM output to large current terminal P50 possible) Clock source						
	Timer counter 1: 8-bit × 1 (square-wave output, event count, synchronous output event) Clock source						
	Timer counter 0, 1 can be cascade-connected.						
	Timer counter 2: 8-bit × 1 (square-wave output, additional pulse type 10-bit PWM output, event count, synchronous output event, simple pulse width measurement) (square-wave/PWM output to large current terminal P52 possible) Clock source						
	•	ck frequency; 1/1, 1/4, 1/16, 1/64, 1/128 of OSC oscillation of XI oscillation clock frequency; external clock input					
	Timer counter 2, 3 can be cascade-connected.						
	•	requency; 1/1, 1/4096, 1/8192 of OSC oscillation clock 6, 1/8192 of XI oscillation clock frequency pare register 6					
	possible) Clock source 1/1, 1/2, 1/4, 1/16 of s	e) (square-wave/PWM output to large current terminal Ps system clock frequency; 1/1, 1/2, 1/4, 1/16 of OSC uency; 1/1, 1/2, 1/4, 1/16 of external clock input frequency					

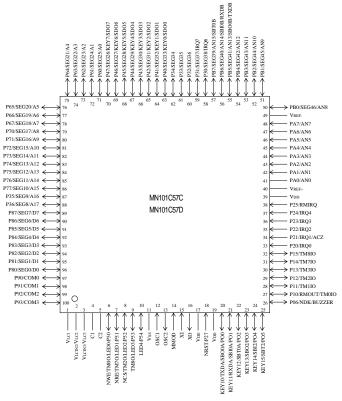
Timer Counter (Continue)		Timer counter 8: 16 bit × 1 (square-wave/16-bit PWM output [duty continuous variable], event count, pulse width measurement, input capture) (square-wave/PWM output to large current terminal P53 possible) Clock source				
		Timer counters 7, 8 can be cascade-connected. (square-wave output, PWM, input capture, pulse width measurement is possible as a 32-bit timer.)				
		Time base timer (one-minute count setting) Clock source				
		Watchdog timer Interrupt source				
Serial Interfac	е	Serial 0: synchronous type/UART (full-duplex) × 1 Clock source ····································				
		Serial 2 : synchronous type × 1 Clock source				
Remote Contr	ol Interface	Remote control output: timer 0 and 3 output: the remote control carrier output of 1/2 and 1/3 duty. Remote control reception: correspondence with low speed clock waiting Correspondence with AEHA (Association for Electric Home Appliances) format (selection of a formart is available by the set-up)				
I/O Pins	I/O	77 • Common use • Specified pull-up resistor available • Input/output selectable (bit unit)				
	Input	6 • Common use • Specified pull-up resistor available				
A/D Inputs		10-bit × 16-ch. (with S/H)				
LCD		47 segments × 4 commons (static, 1/2, 1/3, or 1/4 duty) LCD power supply separated from VDD (usable if VLCD ≤ VDD) LCD power shunt resistance contained				
Special Ports		Buzzer output, remote control carrier signal output, high-current drive port				

Electrical Characteristics

Supply current

Parameter	Symbol	Condition	Limit			Unit
raiailletei	Symbol		min	typ	max	Unit
	IDD1	fosc = 20 MHz, VDD = 5 V		25	60	mA
Operating supply current	IDD2	fosc = 8 MHz, VDD = 5 V		10	25	mA
	IDD3	fx = 32 kHz, VDD = 3 V		30	100	μА
Supply current at HALT	IDD4	$fx = 32 \text{ kHz}, VDD = 3 \text{ V}, Ta = 25^{\circ}\text{C}$		4	8	μA
Supply current at HALI	IDD5	$fx = 32 \text{ kHz}, VDD = 3 \text{ V}, Ta = -40^{\circ}\text{C to } +85^{\circ}\text{C}$			30	μА
Supply current at STOP	IDD6	VDD = 5 V, Ta = 25°C			2	μА
Supply culterit at STOP	IDD7	VDD = 5 V, $Ta = -40$ °C to $+85$ °C			50	μА

Pin Assignment



QFP100-P-1818B *Lead-free (under development)

LQFP100-P-1414 *Lead-free (under planning)

Support Tool

In-circuit Emulator	PX-ICE101C / D + PX-PRB101C57-QFP100-P-1818B-M	
Flash Memory Built-in Type	Туре	MN101CF57D [ES (Engineering Sample) available]
	ROM (× 8-bit)	64 K
	RAM (× 8-bit)	2 K
	Minimum instruction execution time	0.1 μs (at 4.5 V to 5.5 V, 20 MHz)
		$0.25~\mu s$ (at $2.7~V$ to $5.5~V, 8~MHz)$
		62.5 µs (at 2.5 V to 5.5 V, 32 kHz)
	Package	QFP100-P-1818B *Lead-free (under development)
		LQFP100-P-1414 *Lead-free (under planning)

MN101C57C , MN101C57D \square

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